

Features

- Exceeds Requirements of Full Duplex EIA-485 Standard
- Hot Plug Circuitry - Tx and Rx Outputs Remain Three-State During Power-up/Power-down
- Supply voltage: 3.0V ~ 5.5V
- Input Common-mode Range: -7V ~ +12 V
- Data Rate: 32Mbps
- Up to 256 Nodes on a Bus (1/8 unit load)
- Full Fail-safe Receiver (Open, Short, Terminated)
- Bus-Pin Protection:
 - ±20 kV HBM ESD
 - ±12 kV IEC61000-4-2 Contact Discharge
 - ±15 kV IEC61000-4-2 Air Discharge
- -40°C to 125°C Operation Temperature Range

Applications

- Home Appliance
- Motor Drives
- Industrial Control
- Grid Infrastructure
- Video Surveillance
- Communication Infrastructure

Description

The TPT480 and TPT482 is IEC61000 ESD protected, which support ±12 kV IEC contact and ±15 kV IEC air discharge. 3.0V ~ 5.5V transceivers that meet the RS-485 and RS-422 standards for Full Duplex communication.

Transmitters in this family deliver exceptional differential output voltages into the RS-485 required 54Ω load. The devices have very low bus currents so they present a true “1/8 unit load” to the RS-485 bus. This allows up to 256 transceivers on the network without using repeaters.

Receiver (Rx) inputs feature a “Full Fail-Safe” design, which ensures a logic high Rx output if Rx inputs are floating, shorted, or on a terminated but undriven bus.

The TPT480x is designed for full-duplex RS485, and support SOP8, DFN3X3-8, MSOP10 and SOP14 package, which is characterized from -40°C to 125°C.

Device Table

Part	Duplex	Enable	Data Rate	Package
TPT480	Full	Yes	32Mbps	SOP-8 DFN3X3-8
TPT482	Full	Yes	32Mbps	MSOP10 SOP-14

Simplified Schematic

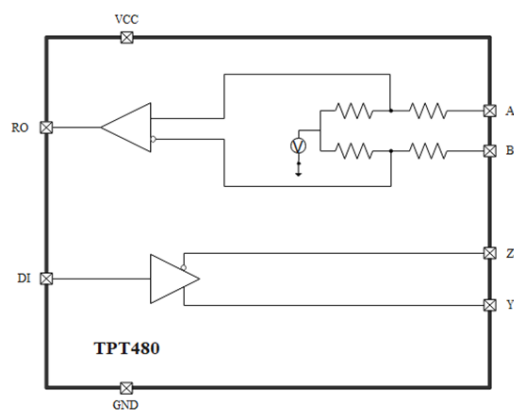


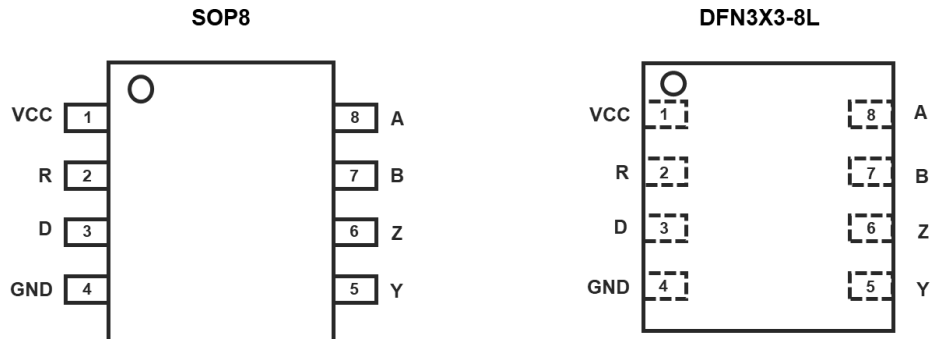
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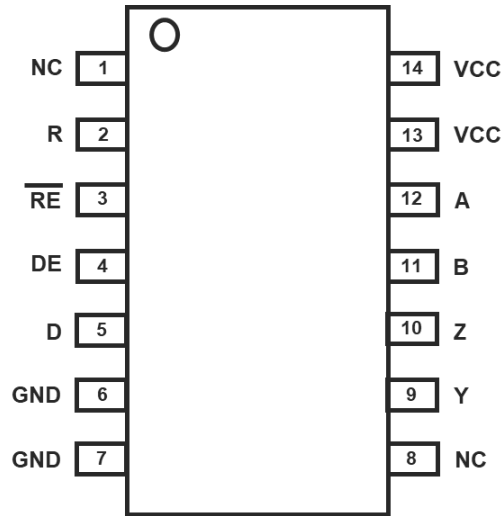
Revision History

Date	Revision	Notes
2021/06/11	Rev. Pre0	Definition Version Pre.0
2023/01/31	Rev. A0	Released version
2023/04/04	Rev. A1	Updated DF6R POD as DFN3X3-8-B
2023/08/15	Rev. A2	Added TPT482 MSOP10 version

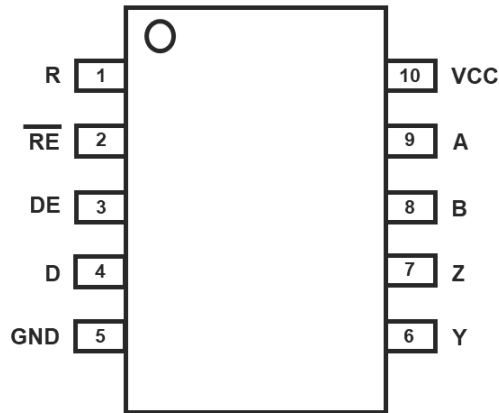
Pin Configuration and Functions – TPT480



Pin No.	Pin Name	I/O	Description
1	VCC	Power	Power Supply
2	R	Digital output	Receiver Output
3	D	Digital input	Driver Input
4	GND	Ground	Ground
5	Y	Bus output	Noninverting Driver Output
6	Z	Bus output	Inverting Driver Output
7	B	Bus input	Inverting Receiver Input
8	A	Bus input	Noninverting Receiver Input

Pin Configuration and Functions – TPT482-SO2R


Pin No.	Pin Name	I/O	Description
1	NC		
2	R	Digital output	Receiver Output
3	/RE	Digital input	Receiver Output Enable
4	DE	Digital input	Driver Output Enable
5	D	Digital input	Driver Input
6	GND	Ground	Ground
7	GND	Ground	Ground
8	NC		
9	Y	Bus output	Noninverting Driver Output
10	Z	Bus output	Inverting Driver Output
11	B	Bus input	Inverting Receiver Input
12	A	Bus input	Noninverting Receiver Input
13	VCC	Power	Power Supply
14	VCC	Power	Power Supply

Pin Configuration and Functions – TPT482-VS2R


Pin No.	Pin Name	I/O	Description
1	R	Digital output	Receiver Output
2	/RE	Digital input	Receiver Output Enable
3	DE	Digital input	Driver Output Enable
4	D	Digital input	Driver Input
5	GND	Ground	Ground
6	Y	Bus output	Noninverting Driver Output
7	Z	Bus output	Inverting Driver Output
8	B	Bus input	Inverting Receiver Input
9	A	Bus input	Noninverting Receiver Input
10	VCC	Power	Power Supply

Functional Table

Driver Function Table

Input	Enable	Output	Output	Description
D	DE	Y	Z	
H	H	H	L	Actively drives bus High
L	H	L	H	Actively drives bus Low
X	L	Z	Z	Driver disabled
Open	H	H	L	Actively drives bus High by default

X = don't care

Z = high impedance

Receiver Function Table

Input	Input	Output	Description
A-B	/RE	R	
>-50mV	L	H	Receive valid bus High
-200mV<Input<-50mV	L	?	Indeterminate bus state
<-200mV	L	L	Receive valid bus Low
X	H	Z	Receiver disabled
Open	L	H	Fail-safe high output
Short	L	H	Fail-safe high output
Idle (Terminated)	L	H	Fail-safe high output

X = don't care

Z = high impedance

Absolute Maximum Ratings

Parameters	Rating
VCC to GND	-0.3V to +7V
Voltage at Logic pin: D, DE, /RE, R	-0.3V to VCC + 0.3V
Voltage at Bus pin: A, B, Y, Z ⁽¹⁾	-15V to +15V
Operating Temperature Range	-40°C to 125°C
Storage Temperature Range	-65°C to 150°C
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 10 sec)	260°C

(1) Support $\pm 15V$ in receiver mode, and -8 ~+13V in driver mode

(2) Stresses beyond the *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*.

Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	3.0		5.5	V
V _I	Input voltage at any bus terminal ⁽¹⁾	-7		12	V
V _{IH}	High-level input voltage (driver, driver enable, and receiver enable inputs)	2		VCC	V
V _{IL}	Low-level input voltage (driver, driver enable, and receiver enable inputs)	0		0.8	V
V _{ID}	Differential input voltage	-7		12	V
R _L	Differential load resistance	54			Ω
T _A	Operating ambient temperature	-40		125	°C
T _J	Junction temperature	-40		150	°C

(1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.

ESD Rating

		Value	Unit
IEC-61000-4-2, Contact Discharge	Bus Pin	±12	kV
IEC-61000-4-2, Air-Gap Discharge	Bus Pin	±15	kV
HBM, per ANSI/ESDA/JEDEC JS-001 / ANSI/ESD STM5.5.1	Bus Pin	±20	kV
	All Pin Except Bus Pin	±4	kV
CDM, per ANSI/ESDA/JEDEC JS-002	All Pin	±1.5	kV

Thermal Information

Package Type	θ _{JA}	θ _{JC}	Unit
8-Pin SOP	120	64	°C/W
8-Pin DFN	65	45	°C/W
10-Pin MSOP	150	58	°C/W
14-Pin SOIC	102	39	°C/W

Electrical Characteristics

All test condition is $V_{CC} = 3.3V \sim 5.0V$, $T_A = -40 \sim +125^\circ C$, unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	MAX	Unit	
V _{OD}	Driver differential output voltage magnitude	R _L = 54 Ω, V _{CC} =3.3V	1.5	2.2	V	
		R _L = 54 Ω, V _{CC} =5.0V	2.0	3.3	V	
		R _L = 100 Ω, V _{CC} = 3.3V	1.5	2.6	V	
		R _L = 100 Ω, V _{CC} = 5.0V	3.0	3.9	V	
Δ V _{OD}	Change in magnitude of driver differential output voltage	R _L = 54 Ω, C _L = 50 pF, 375 Ω on A/B: -7 V to 12V, V _{CC} =3.3V	-50	50	mV	
V _{OC(SS)}	Steady-state common-mode output voltage	Center of two 27-Ω load resistors	1	V _{CC} /2	3	V
ΔV _{OC}	Change in differential driver output common-mode voltage		-200	200	mV	
C _{OD}	Differential output capacitance [1]		15		pF	
V _{IT+}	Positive-going receiver differential input voltage threshold			-110	-50	mV
V _{IT-}	Negative-going receiver differential input voltage threshold		-200	-130	mV	
V _{HYS}	Receiver differential input voltage threshold hysteresis (V _{IT+} - V _{IT-}) [1]			50	mV	
V _{OH}	Receiver high-level output voltage	V _{CC} = 3.3 V, I _{OH} = -8 mA	2.6	3.0	V	
		V _{CC} = 5 V, I _{OH} = -8 mA	4.1	4.8		
V _{OL}	Receiver low-level output voltage	V _{CC} = 3.3 V, I _{OH} = -8 mA		0.19	0.4	V
		V _{CC} = 5 V, I _{OH} = -8 mA		0.02	0.4	
V _{IH}	Input High Logic Level	D, DE, /RE	2.0		V	
V _{IL}	Input Low Logic Level	D, DE, /RE		0.8	V	
I _{IN}	Driver input, driver enable, and receiver enable input current	D, DE, /RE	-5	5	μA	
I _{OZ}	Driver output high-Z current	V _O = -7V	-100	0	μA	
		V _O = 12V	0	125		
I _{OZ}	Receiver high-Z current	V _O = 0 V or V _{CC}	-1	1	μA	
I _{OS}	Driver short-circuit output current	V _Y , V _Z = -7V ~ 12V	-250	250	mA	
		V _Y , V _Z = 0V or V _{CC}	-180	180	mA	
I _{IAB}	Bus input current (disabled driver)	DE = 0 V, RE = V _{CC}	V _I = 12 V,	55	125	μA
			V _I = -7 V,	-100	-50	μA
I _{CC}	Supply current (quiescent), 32Mbps	Driver and Receiver enabled	DE=V _{CC} , RE = GND, No load	1200	2500	μA
		Driver enabled, receiver disabled	DE=V _{CC} , RE = V _{CC} , No load	1200	2500	μA
		Driver disabled, receiver enabled	DE=GND, RE = GND, No load	1000	2200	μA
		Driver and receiver disabled	DE=GND, RE = V _{CC} , No load	-5	5	μA

Note:

[1]. Parameters are provided by lab bench test and design simulation

Switching Characteristics, VCC= 5.0V

Parameter	Conditions	Min	Typ	Max	Units		
Driver							
t_r, t_f	Driver differential-output rise and fall times ⁽¹⁾	54 Ω , CL=50pF	See Figure 2	4	6	10	ns
t_{PHL}, t_{PLH}	Driver propagation delay				19	30	
tSK(P)	Driver pulse skew, $ t_{PHL} - t_{PLH} ^{(2)}$					10	
t_{PHZ}, t_{PLZ}	Driver disable time	/RE=0 or VCC	See Figure 3		37	50	ns
t_{PZH}, t_{PZL}	Driver enable time	Receiver enabled			21	40	ns
		Receiver disabled		1760	2500		
Receiver							
t_r, t_f	Driver differential-output rise and fall times ⁽¹⁾			2	4	6	ns
t_{PHL}, t_{PLH}	Receiver propagation delay time				36	45	ns
tSK(P)	Receiver pulse skew, $ t_{PHL} - t_{PLH} ^{(2)}$					20	
t_{PHZ}, t_{PLZ}	Receiver disable time	DE=0 or VCC	See Figure 6		15	25	ns
t_{PZH}, t_{PZL}	Receiver enable time	Driver enabled			14	25	ns
		Driver disabled		1750	2500		

Note:

(1) For the typical value of t_r, t_f , it is provided by lab bench test. The maximum and minimum value is provided by design simulation.

(2) The maximum value of tSK(P) is provided by design simulation.

Switching Characteristics, VCC=3.3V

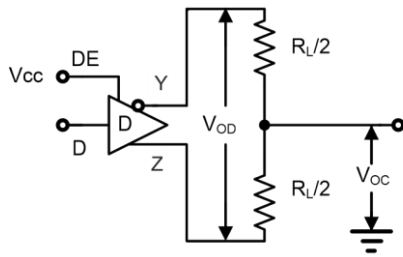
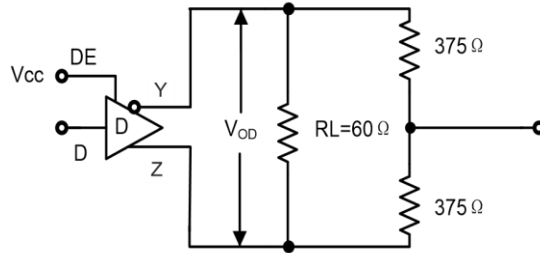
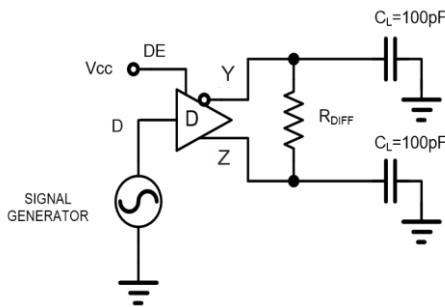
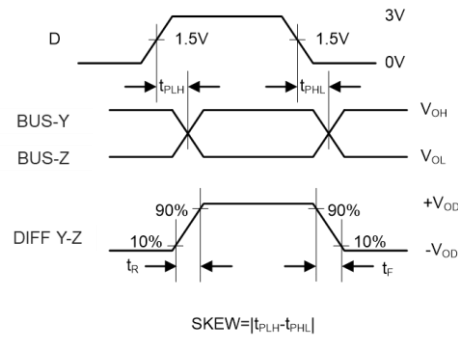
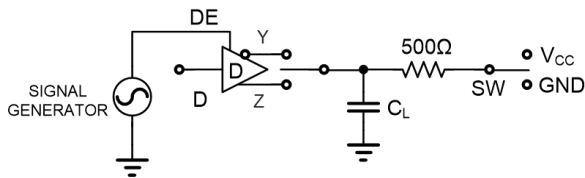
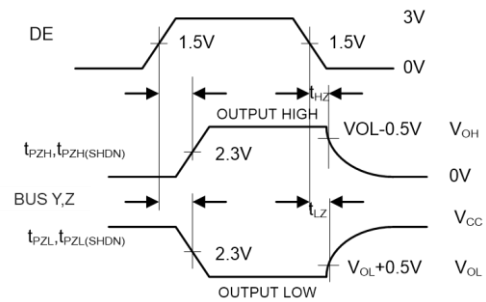
Parameter	Conditions	Min	Typ	Max	Units		
Driver							
t_r, t_f	Driver differential-output rise and fall times ⁽¹⁾	54 Ω , CL=50pF	See Figure 2	4	6	14	ns
t_{PHL}, t_{PLH}	Driver propagation delay				22	30	
tSK(P)	Driver pulse skew, $ t_{PHL} - t_{PLH} ^{(2)}$					10	
t_{PHZ}, t_{PLZ}	Driver disable time	/RE=0 or VCC	See Figure 3		40	55	ns
t_{PZH}, t_{PZL}	Driver enable time	Receiver enabled			30	50	ns
		Receiver disabled		2560	4000		

Parameter	Conditions	Min	Typ	Max	Units		
Receiver							
t_r, t_f	Driver differential-output rise and fall times ⁽¹⁾			2	4	8	ns
t_{PHL}, t_{PLH}	Receiver propagation delay time				47	60	ns
$t_{SK(P)}$	Receiver pulse skew, $ t_{PHL} - t_{PLH} $ ⁽²⁾					20	
t_{PHZ}, t_{PLZ}	Receiver disable time	DE=0 or VCC	See Figure 6		21	30	ns
t_{PZH}, t_{PZL}	Receiver enable time	Driver enabled			17	30	ns
		Driver disabled			2550	4000	

Note:

(1) For the typical value of t_r, t_f , it is provided by lab bench test. The maximum and minimum value is provided by design simulation.

(2) The maximum value of $t_{SK(P)}$ is provided by design simulation.

Test Circuits and Waveforms

Figure 1A. VOD and VOC

Figure 1B. VOD with Common Mode Load
Figure 1. DC Driver Test Circuits

Figure 2A. Test Circuit
Figure 2. Driver Propagation Delay and Differential Transition Times

Figure 2B. Measurement Points

Figure 3A. Test Circuit

Figure 3B. Measurement Points
Figure 3. Driver Enable and Disable Times

PARAMETER	OUTPUT	RE	DI	SW	CL (pF)
tPHZ	Y/Z	X	1/0	GND	15
tPLZ	Y/Z	X	0/1	VCC	15
tPZH	Y/Z	0	1/0	GND	100
tPZL	Y/Z	0	0/1	VCC	100
tPZH(SHDN)	Y/Z	1	1/0	GND	100
tPZL(SHDN)	Y/Z	1	0/1	VCC	100

Test Circuits and Waveforms (continue)

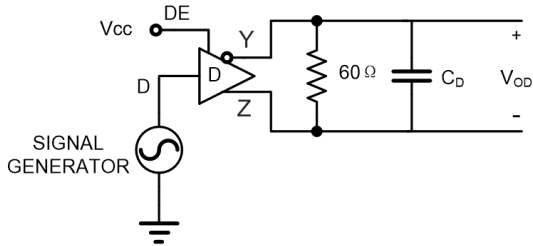


Figure 4A. Test Circuit

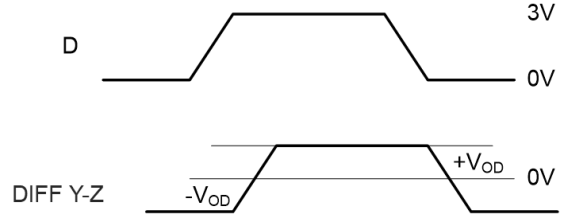


Figure 4B. Measurement Points

Figure 4. Driver Data rate

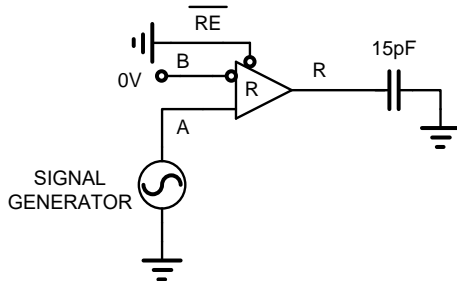


Figure 5A. Test Circuit

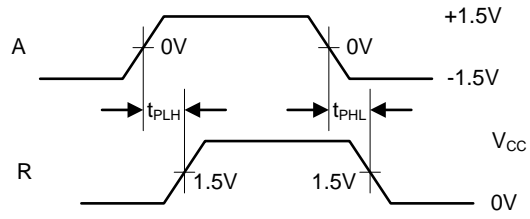


Figure 5B. Measurement Points

Figure 5. Receiver Propagation Delay and Data rate

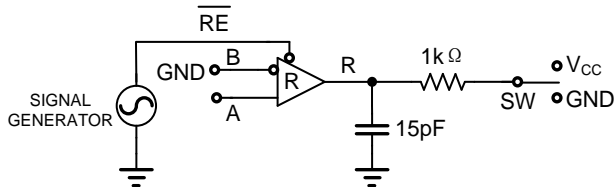


Figure 6A. Test Circuit

PARAMETER	DE	A	SW
tPHZ	1	+1.5V	GND
tPLZ	1	-1.5V	VCC
tPZH	1	+1.5V	GND
tPZL	1	-1.5V	VCC
tPZH(SHDN)	0	+1.5V	GND
tPZL(SHDN)	0	-1.5V	VCC

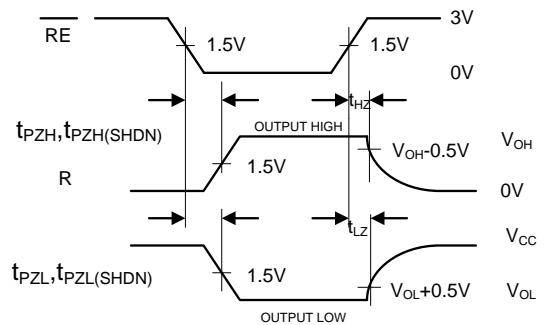
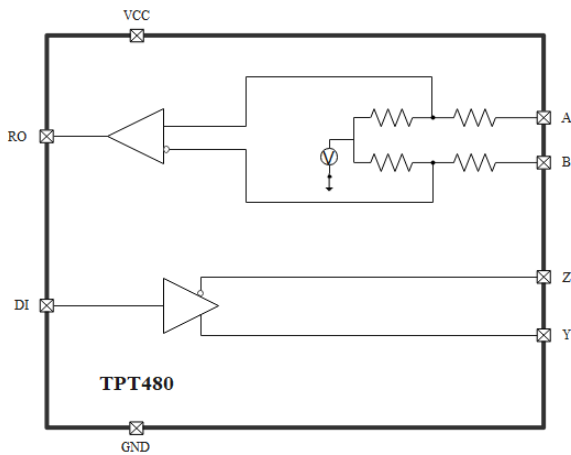
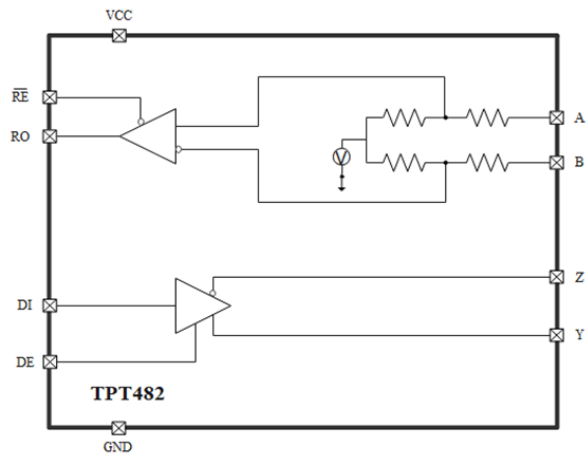


Figure 6B. Measurement Points

Figure 6. Receiver Enable and Disable Times

Function Block diagram:

Figure 7-A. TPT480 block diagram

Figure 7-B. TPT482 block diagram

Theory of Operation

General description

The TPT480/482 is a Full-Duplex RS-485/RS-422 transceivers with robust HBM and IEC 61000 ESD protection. The device build in fail-safe circuit, when the receiver input is open or shorted, or idle mode, it will generate a logic-high receiver output. The TPT48x supports hot-swap function allowing line insertion to avoid wrong data transmission, and optimizes the drivers slew-rate to minimize EMI and reduce reflections caused by different terminated cables, then TPT48x can support the high communication speed up to 32Mbps.

The TPT48x operates from a single +3.3V to 5.0V power supply, the driver is designed with output short-circuit current limitation, together with thermal-shutdown circuitry to protect drivers in the status of excessive power dissipation. In active mode, the thermal-shutdown circuitry places the driver outputs into a high-impedance state.

In the typical RS485 communication, twisted-pair lines are connected backward in the network.

Application Information

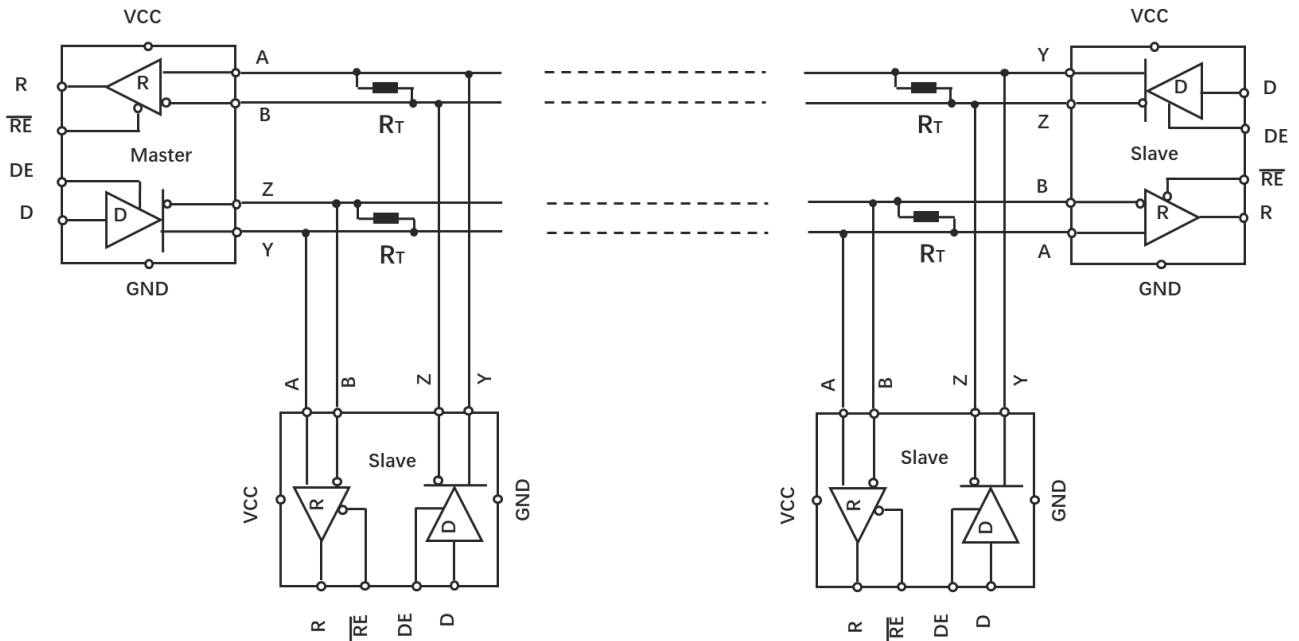
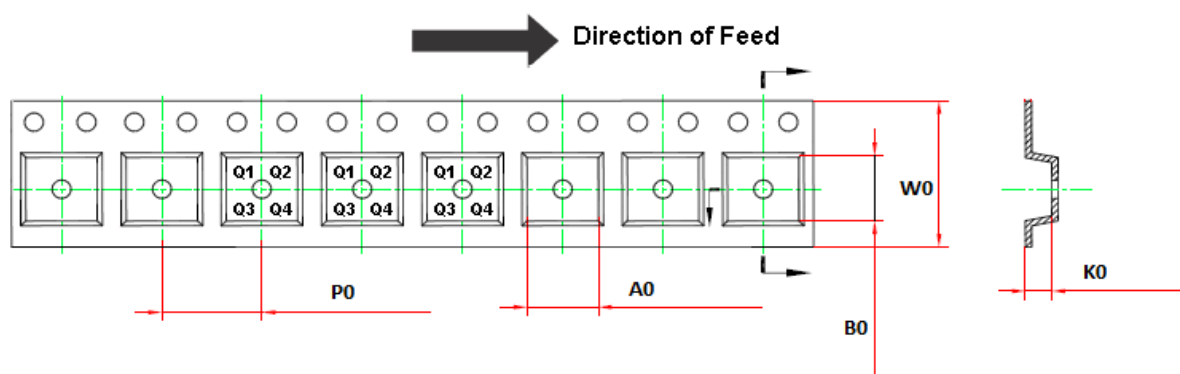
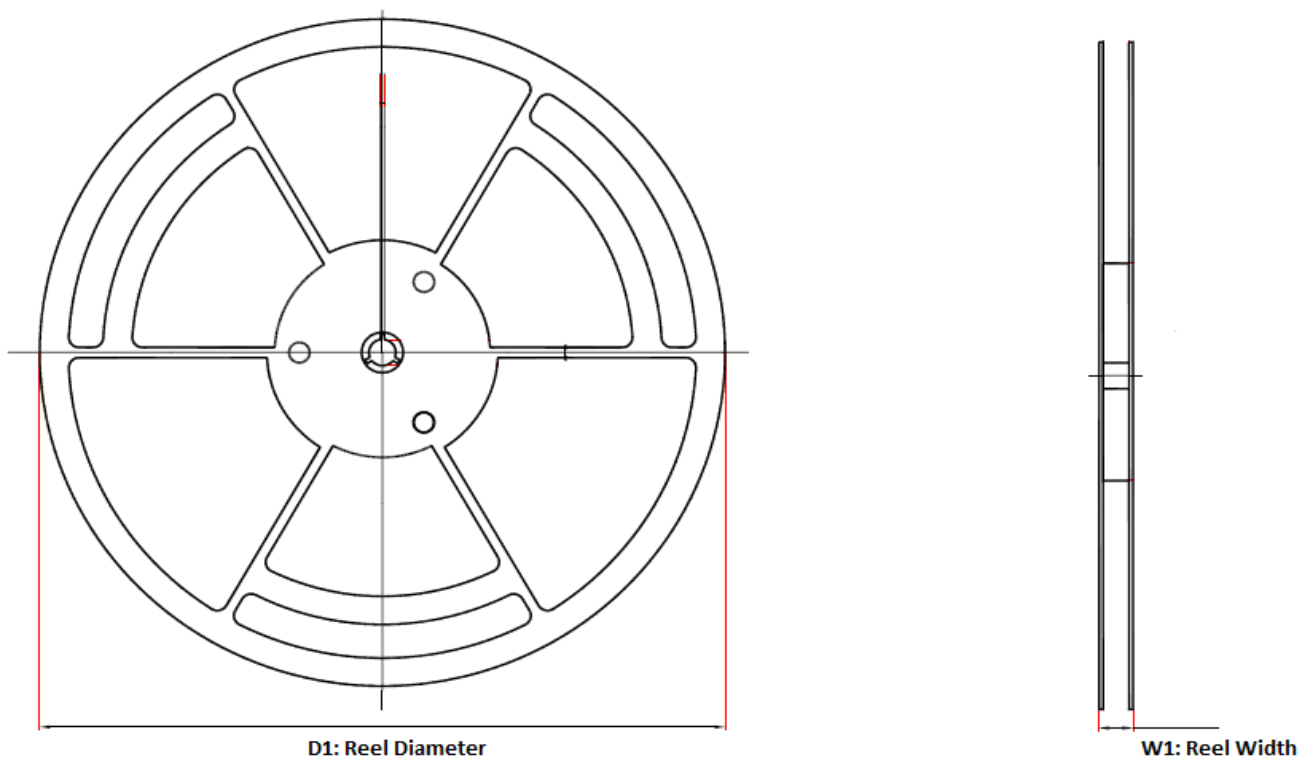


Figure 8. Typical RS485 communication network with enable function

The TPT480 transceiver is designed for bidirectional RS485/422 data communications on multipoint bus transmission lines. Figure 8 shows typical network applications circuit to support up to 256 nodes. To minimize line reflections, terminate the line at both ends in its characteristic impedance, one 120ohm load in master side, and another 120ohm load in the end of slave side, and limit stub lengths off the main line as short as possible.

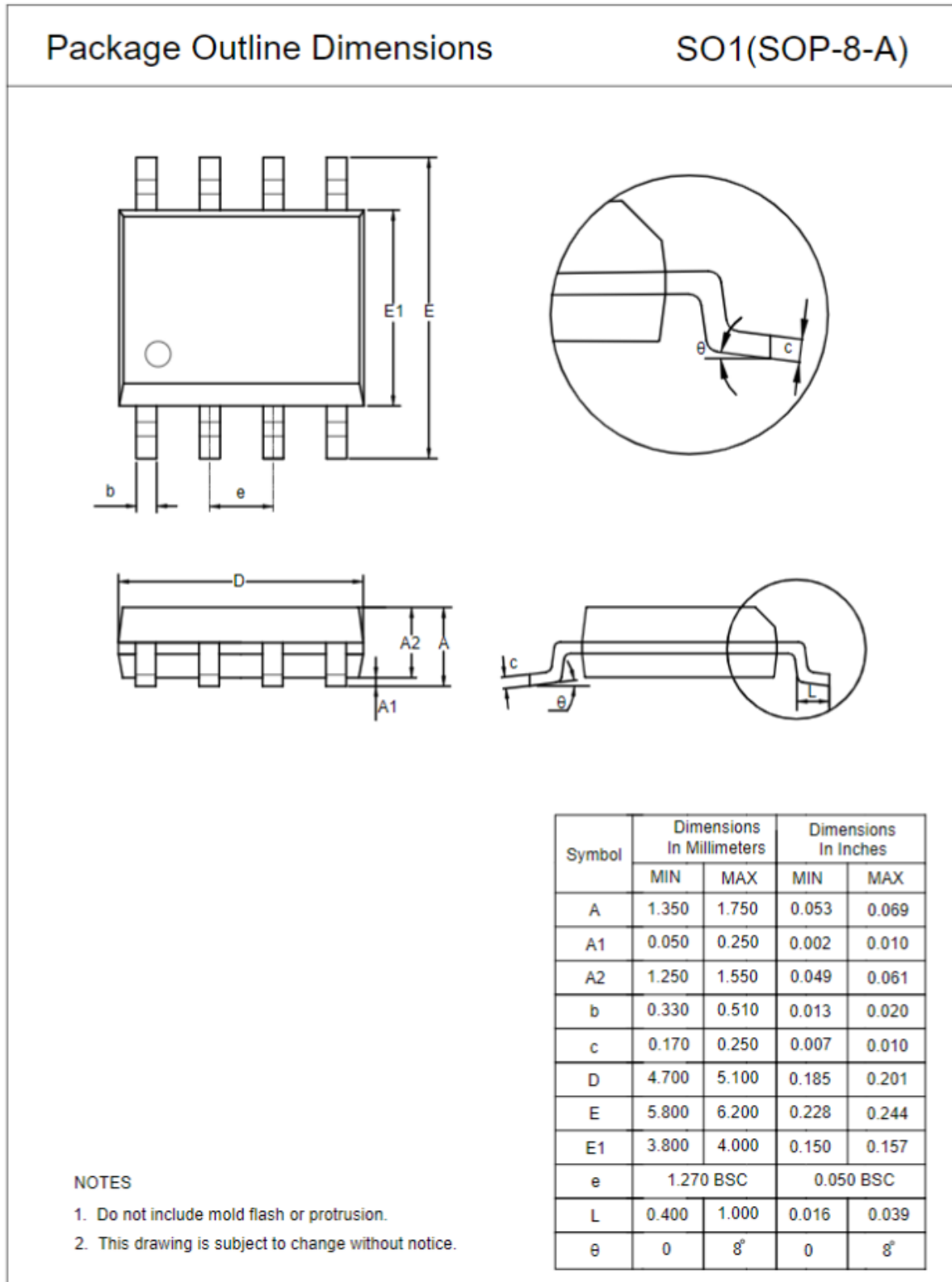
Tape and Reel Information

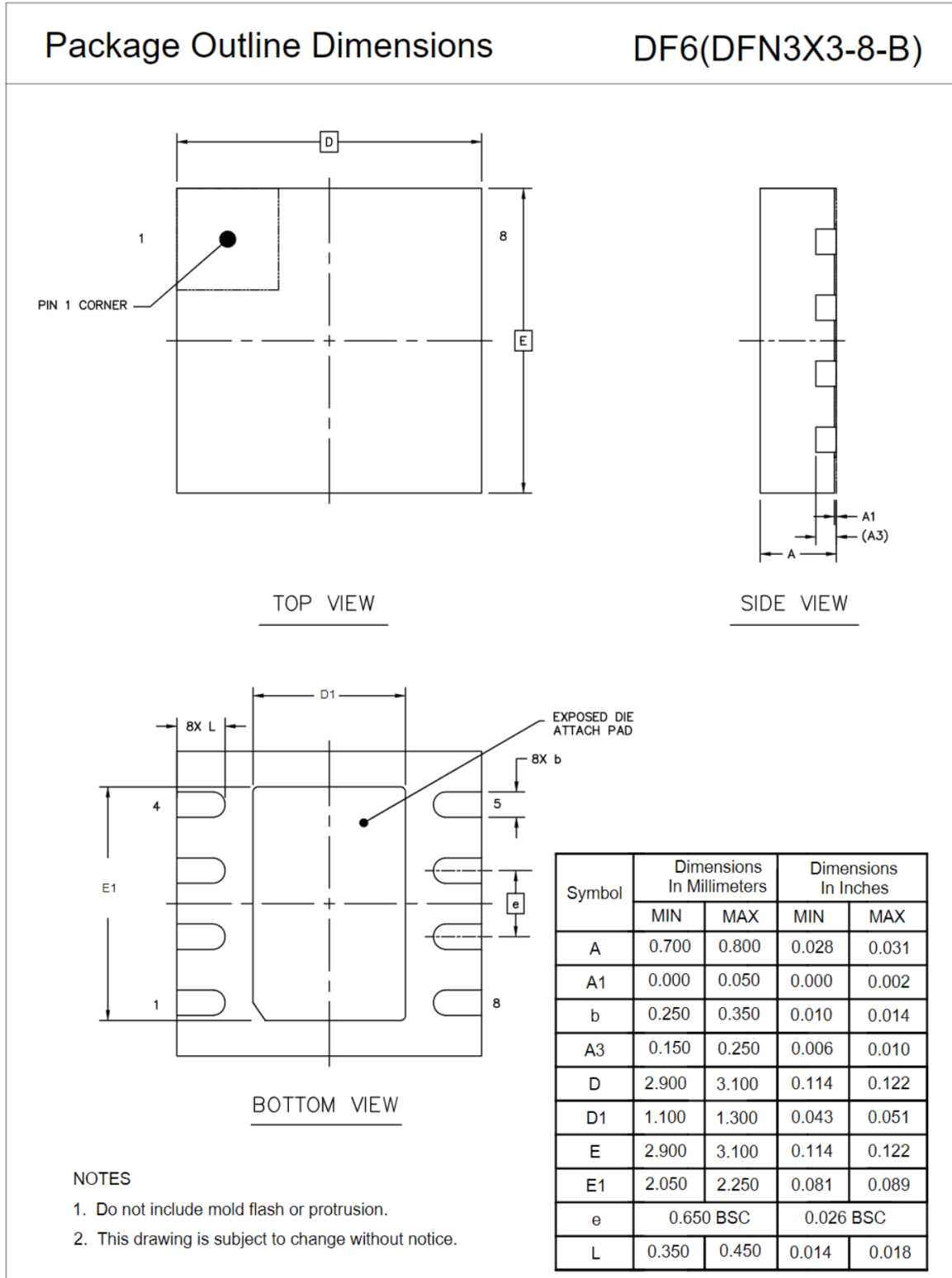


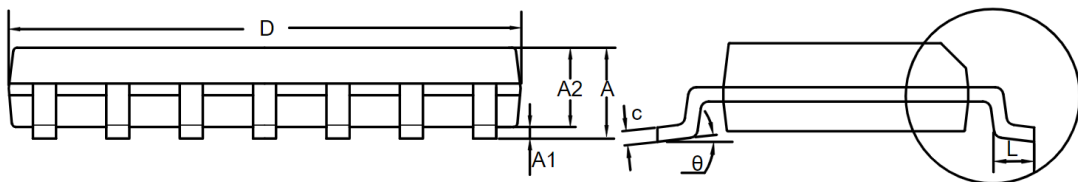
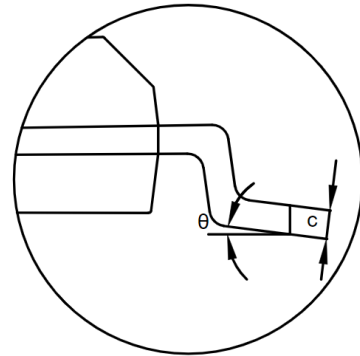
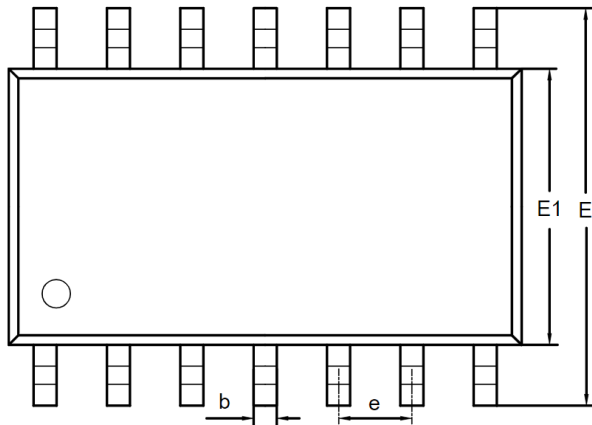
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TPT480L1-SO1R	8-Pin SOP	330.0	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPT480-DF6R	DFN3X3-8L	330.0	17.6	3.3	3.3	1.1	8.0	12.0	Q1
TPT482-SO2R	14-Pin SOP	330.0	21.6	6.5	9.0	2.1	8.0	16.0	Q1
TPT482-VS2R	10-Pin MSOP	330.0	17.6	5.2	3.3	1.5	8.0	12.0	Q1

Package Outline Dimensions

SO1R (SOP-8)



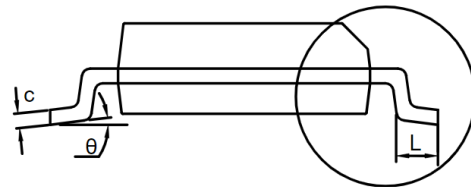
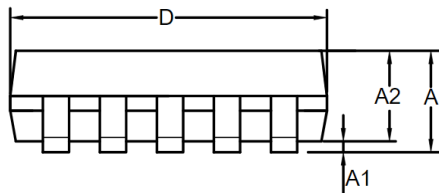
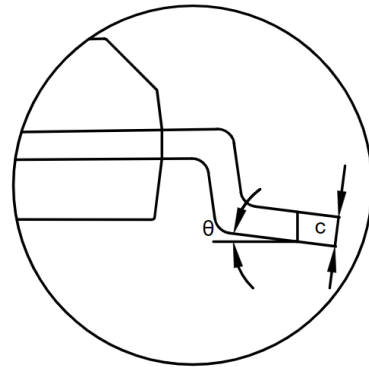
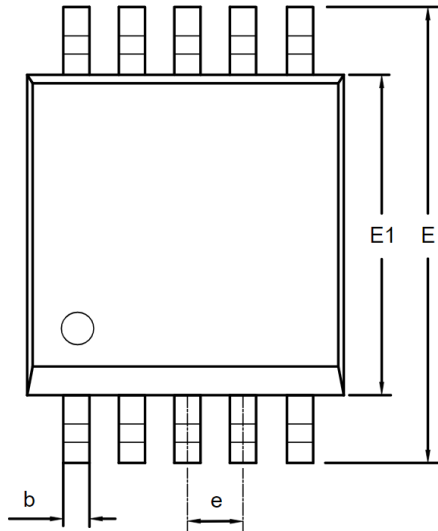
Package Outline Dimensions (Continued)
DF6R (DFN3x3-8L)


Package Outline Dimensions (Continued)
SO2R (SOP-14)
Package Outline Dimensions
SO2(SOP-14-A)


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.050	0.250	0.002	0.010
A2	1.250	1.650	0.049	0.065
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
e	1.270 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Package Outline Dimensions (Continued)
VS2R (MSOP-10)
Package Outline Dimensions
VS2(MSOP-10-A)


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.800	1.100	0.031	0.043
A1	0.050	0.150	0.002	0.006
A2	0.750	0.950	0.030	0.037
b	0.180	0.280	0.007	0.011
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
E	4.700	5.100	0.185	0.201
E1	2.900	3.100	0.114	0.122
e	0.500 BSC		0.020 BSC	
L	0.400	0.800	0.016	0.031
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPT480L1-SO1R	-40 to 125°C	SOP8	T480	1	Tape and Reel, 4000	Green
TPT480-DF6R	-40 to 125°C	DFN3X3-8	T480	3	Tape and Reel, 4000	Green
TPT482-SO2R	-40 to 125°C	SOP14	T482	3	Tape and Reel, 2,500	Green
TPT482-VS2R	-40 to 125°C	MSOP10	T482	3	Tape and Reel, 3,000	Green

(1). Future product, contact 3PEAK factory for more information and sample

(2). Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

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